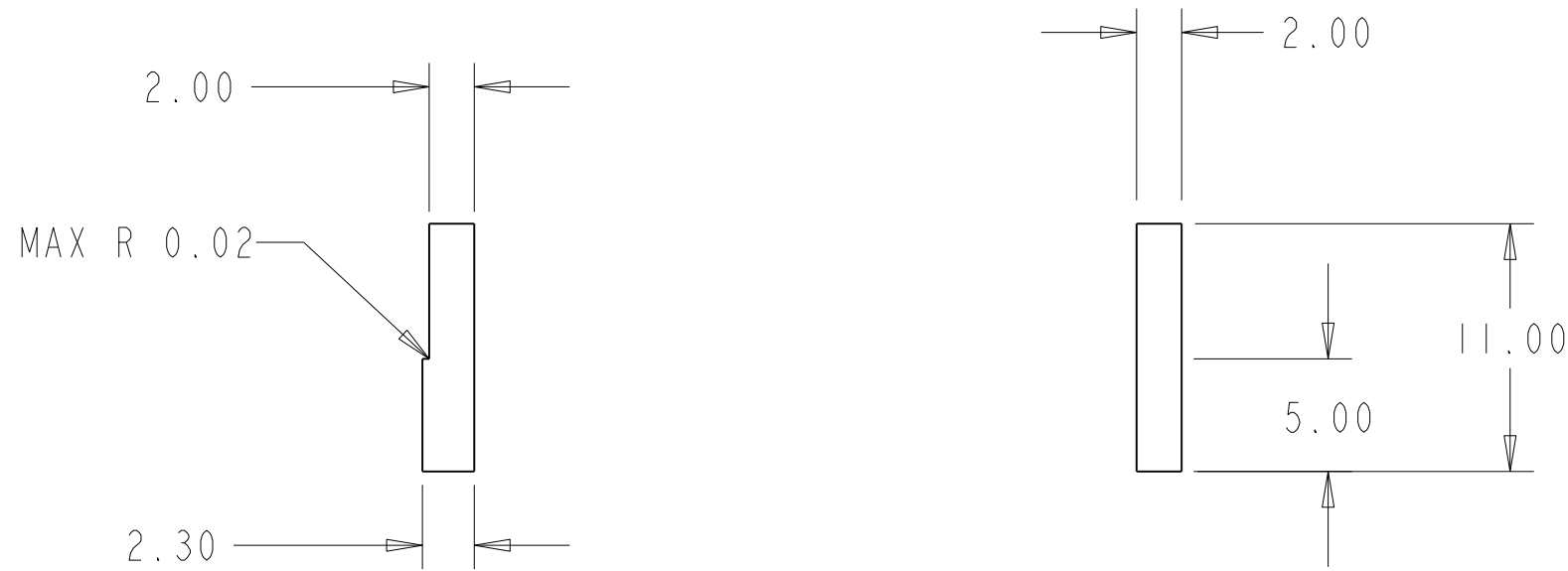




REV	DWG	CHK	DATE	CHANGES				DESCRIPTION				BFG 3D-CC	
UNLESS OTHERWISE SPECIFIED				SHOP ORDERS				ERNEST ORLANDO LAWRENCE				MATERIAL	
X.X ±0.1				ACCT NO. SEE J.O. NO. 120				BERKELEY NATIONAL LABORATORY				DO NOT SCALE PRINTS	
X.XX ±0.01				DEL TO JS WIRTH				UNIVERSITY OF CALIFORNIA - BERKELEY					
X.XXX ±0.001				FINISH 125 μm				ATLAS PIXEL DETECTOR					
DO NOT SCALE PRINT				PROJECT NAME ATL-IP-ED-0036				DISK SECTOR, MODULE LOCAL SUPPORT					
THREADS ARE CLASS 2				PROJECT NUMBER				BEAM HARDPOINT, SECTOR FACING SUPPORT					
CHAMFER ENDS OF ALL SCREW THREADS 30°				PROJECT NAME US ATLAS SILICON SUBSYSTEM				MICROFILMED:				DWG. TYPE PART	
CUT ROUND, 1.5 THREAD RELIEF ON MACHINED THREADS				DWG BY D UKEN				DATE 18-Feb-01				SHOWN ON 21f406	
BREAK EDGES .016 MAX. ON MACHINED WORK				CHK BY J WIRTH				DATE 29-JUN-01				SCALE: 3.000	
REMOVE BURRS, WELD SPLATTER & LOOSE SCALE				APR BY E ANDERSSSEN				PATENT CLEAR:				DESIGN ACCT. NO. PIAP11	
IN ACCORDANCE WITH ASME Y14.5M & B46.1												CATEGORY CODE AP6110	
												SHEET 1 OF 1	
												21F358	
												REV. 1	

Dwg. File: 21F358.Model File: 21F358